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Diodes Incorporated DMHC3025LSD-13

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Datasheet of DMHC3025LSD-13 - MOSFET 2N/2P-CH 30V 8SOIC

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DMHC3025LSD

30V COMPLEMENTARY ENHANCEMENT MODE MOSFET H-BRIDGE

Product Summary

Device	V _{(BR)DSS}	R _{DS(ON)} max	I _D max T _A = +25°C
NI Obsessed	00)/	$25m\Omega$ @ V_{GS} = $10V$	6.0
N-Channel	el 30V	$40m\Omega$ @ $V_{GS} = 4.5V$	4.6
D. Oharara	001/	$50m\Omega$ @ $V_{GS} = -10V$	-4.2
P-Channel -30V		80mΩ @ V _{GS} = -4.5V	-3.2

Description

This new generation complementary MOSFET H-Bridge features low on-resistance achievable with low gate drive.

Applications

- DC Motor control
- DC-AC Inverters

Features

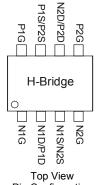
- 2 x N + 2 x P channels in a SOIC package
- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Totally Lead-Free & Fully RoHS compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

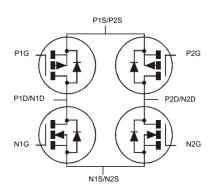
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See diagram
- Terminals: Finish Matte Tin annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.008 grams (approximate)



Top View



Pin Configuration



Internal Schematic

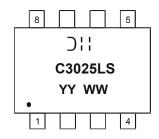
Ordering Information (Note 4)

Part Number	Case	Packaging
DMHC3025LSD-13	SO-8	2500/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



⊃¦¦ = Manufacturer's Marking C3025LS = Product Type Marking Code YYWW = Date Code Marking YY = Year (ex: 09 = 2009) WW = Week (01 - 53)

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Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Units	
Total Power Dissipation (Note 5)		P_{D}	1.5	W	
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	D	83		
Thermal Resistance, Junction to Ambient (Note 5)	t < 10s	$R_{\theta JA}$	50	°C/W	
Thermal Resistance, Junction to Case		$R_{ heta JC}$	14.5		
Operating and Storage Temperature Range		$T_{J_i}T_{STG}$	-55 to 150	°C	

Maximum Ratings N-CHANNEL (@TA = +25°C, unless otherwise specified.)

Characteristic			Symbol	Value	Units
Drain-Source Voltage			V _{DSS}	30	V
Gate-Source Voltage			V _{GSS}	±20	V
Continuous Drain Current (Note 5) // - 40 //	Steady State	T _A = +25°C T _A = +70°C	I _D	6.0 4.8	А
Continuous Drain Current (Note 5) V _{GS} = 10V	t < 10s	T _A = +25°C T _A = +70°C	I _D	7.8 6.1	Α
Continuous Drain Current (Note 5) V 4 5V	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	4.6 3.6	Α
Continuous Drain Current (Note 5) V _{GS} = 4.5V	t < 10s	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	6.1 4.8	Α
Maximum Continuous Body Diode Forward Current (Note 5)			Is	2.5	Α
Pulsed Drain Current (10µs pulse, duty cycle = 1%)			I _{DM}	60	Α

Characteristic			Symbol	Value	Units
Drain-Source Voltage			V_{DSS}	30	V
Gate-Source Voltage			V_{GSS}	±20	V
		$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	-4.2 -3.3	А
Continuous Drain Current (Note 5) V _{GS} = -10V	t < 10s	T _A = +25°C T _A = +70°C	I _D	-5.4 -4.3	А
Continuous Drain Current (Note 5) // - 45/	Steady State	T _A = +25°C T _A = +70°C	I _D	-3.2 -2.5	А
Continuous Drain Current (Note 5) V _{GS} = -4.5V	t < 10s	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	-4.3 -3.3	А
Maximum Continuous Body Diode Forward Current (Note 5)			I _S	-2.5	Α
Pulsed Drain Current (10µs pulse, duty cycle = 1%)			I _{DM}	-30	Α

Note: 5. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

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Electrical Characteristics N-CHANNEL (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 6)							
Drain-Source Breakdown Voltage	BV _{DSS}	30	_	_	V	$V_{GS} = 0V, I_D = 250\mu A$	
Zero Gate Voltage Drain Current	I _{DSS}	_	_	0.5	μA	V _{DS} = 30V, V _{GS} = 0V	
Gate-Source Leakage	I _{GSS}		_	±1	μA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 6)							
Gate Threshold Voltage	V _{GS(th)}	1		2	٧	$V_{DS} = V_{GS}$, $I_D = 250\mu A$	
Static Drain-Source On-Resistance			19	25	mΩ	V _{GS} = 10V, I _D = 5A	
Static Drain-Source On-Resistance	R _{DS (ON)}	_	26	40	11177	V _{GS} = 4.5V, I _D = 4A	
Forward Transfer Admittance	Y _{fs}		4	_	S	$V_{DS} = 5V, I_{D} = 5A$	
Diode Forward Voltage	V _{SD}	_	0.70	1.2	V	V _{GS} = 0V, I _S = 1.7A	
DYNAMIC CHARACTERISTICS (Note 7)							
Input Capacitance	C _{iss}		590	_		V _{DS} = 15V, V _{GS} = 0V, f = 1MHz	
Output Capacitance	Coss	_	122	_	pF		
Reverse Transfer Capacitance	C _{rss}	_	58	_			
Gate resistance	R_g	_	1.5	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge (V _{GS} = 4.5V)	Qg	_	5.4	_			
Total Gate Charge (V _{GS} = 10V)	Qg	_	11.7	_	20	\\\ - 15\\\ \ - 7.0\\	
Gate-Source Charge	Q _{gs}		1.8	_	nC	$V_{DS} = 15V, I_D = 7.8A$	
Gate-Drain Charge	Q_{gd}	_	2.1	_			
Turn-On Delay Time	t _{D(on)}		11.2	_			
Turn-On Rise Time	t _r		15	_	20	$V_{DD} = 15V, V_{GS} = 4.5V,$	
Turn-Off Delay Time	t _{D(off)}		17.5	_	ns	$R_L = 2.4\Omega$, $R_G = 1\Omega$,	
Turn-Off Fall Time	t _f		8.7	_			
Reverse Recovery Time	t _{rr}		18.3	_	ns	104 37/44 5004/ -	
Reverse Recovery Charge	Qrr	_	12	_	nC	I _F = 12A, di/dt = 500A/μs	

Electrical Characteristics P-CHANNEL (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 6)						
Drain-Source Breakdown Voltage	BV _{DSS}	-30	_	_	V	$V_{GS} = 0V, I_D = -250\mu A$
Zero Gate Voltage Drain Current	I _{DSS}	_	_	-0.5	μΑ	$V_{DS} = -30V, V_{GS} = 0V$
Gate-Source Leakage	I _{GSS}	_	_	±1	μA	$V_{GS} = \pm 20V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 6)						
Gate Threshold Voltage	V _{GS(th)}	-1		-2	V	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$
Static Drain-Source On-Resistance		_	43	50	mΩ	$V_{GS} = -10V, I_D = -5A$
Static Drain-Source On-Resistance	R _{DS} (ON)	_	68	80	11177	$V_{GS} = -4.5V$, $I_{D} = -4A$
Forward Transfer Admittance	Y _{fs}	_	3.5	_	S	$V_{DS} = -5V, I_{D} = -5A$
Diode Forward Voltage	V _{SD}	_	-0.7	-1.2	V	V _{GS} = 0V, I _S = -1.7A
DYNAMIC CHARACTERISTICS (Note 7)						
Input Capacitance	C _{iss}	_	631	_	рF	45) () () () (
Output Capacitance	Coss	-	137	_	pF	V _{DS} = -15V, V _{GS} = 0V, -f = 1MHz
Reverse Transfer Capacitance	C _{rss}	_	70	_	pF	-1 - IIVIHZ
Gate resistance	Rg	_	10.8	_	Ω	V _{DS} = 0V, V _{GS} = 0V, f = 1MHz
Total Gate Charge (V _{GS} = 4.5V)	Qq	_	5.5	_	nC	
Total Gate Charge (V _{GS} = 10V)	Qq	_	11.4	_	nC	15)/ 1
Gate-Source Charge	Q _{qs}	_	1.8	_	nC	$V_{DS} = -15V, I_{D} = -6A$
Gate-Drain Charge	Q _{gd}	_	2.4	_	nC	
Turn-On Delay Time	t _{D(on)}	_	7.5	_	ns	
Turn-On Rise Time	t _r	_	4.9	_	ns	$V_{DD} = -15V, V_{GS} = -10V,$
Turn-Off Delay Time	t _{D(off)}	_	28.2	_	ns	$R_G = 6\Omega$, $I_D = -1A$
Turn-Off Fall Time	t _f	_	13.5	_	ns	7
Reverse Recovery Time	t _{rr}	_	15.1	_	ns	1 - 404 - 4:/
Reverse Recovery Charge	Qrr	_	15.3	_	nC	-I _F = 12A, di/dt = 500A/μs

Notes: 6. Short duration pulse test used to minimize self-heating effect.

7. Guaranteed by design. Not subject to product testing.

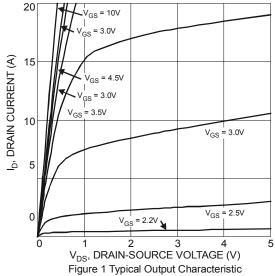
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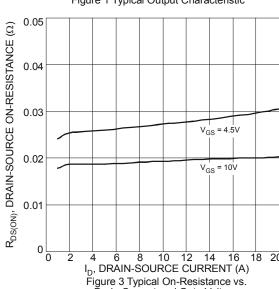
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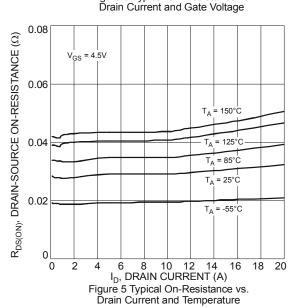


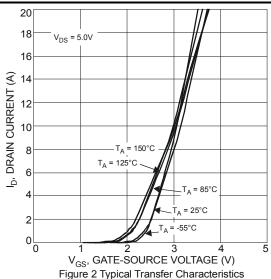
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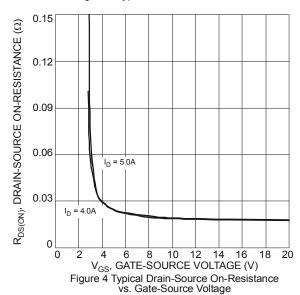
Typical Characteristics - N-CHANNEL











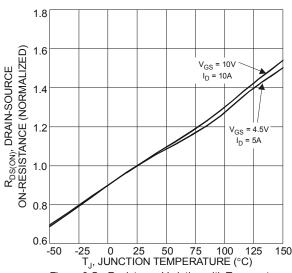
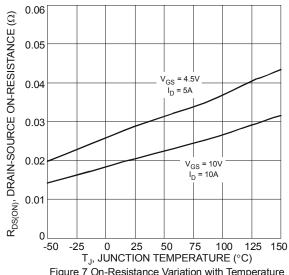
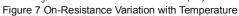


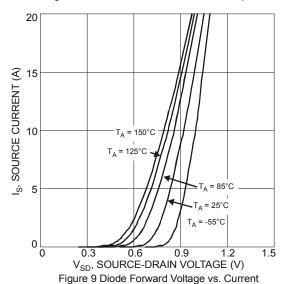
Figure 6 On-Resistance Variation with Temperature



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10 V_{GS} GATE THRESHOLD VOLTAGE (V) V_{DS} = 15V I_D = 7.8A 0 Q_g , TOTAL GATE CHARGE (nC) Figure 11 Gate Charge

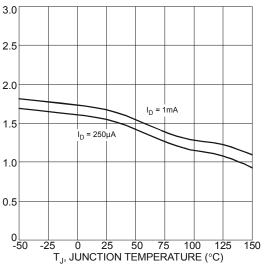
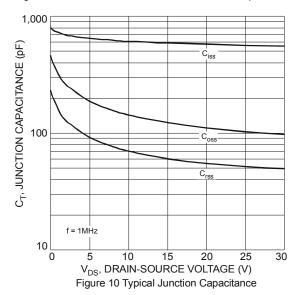


Figure 8 Gate Threshold Variation vs. Ambient Temperature



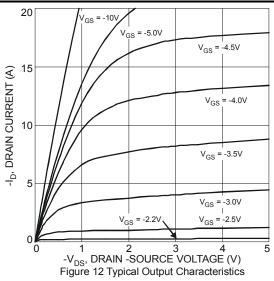
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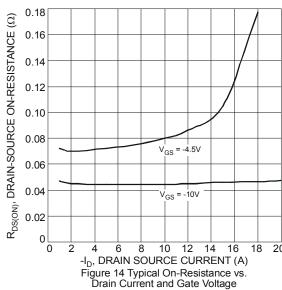
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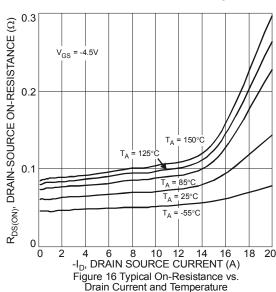


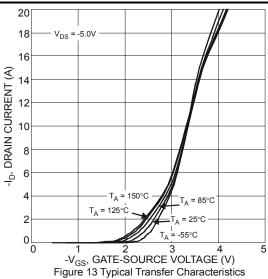
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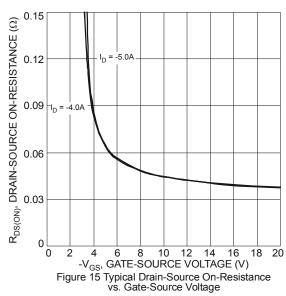
Typical Characteristics - P-CHANNEL

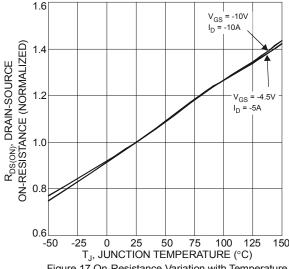














0.03 0.02

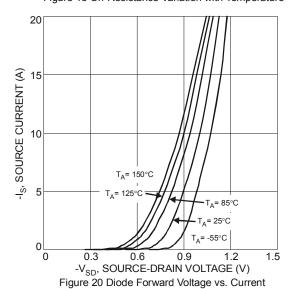
0.01

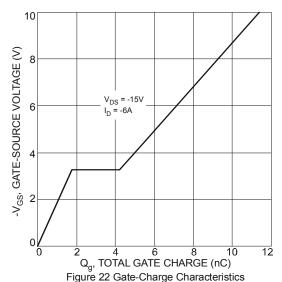
0 -50

0.10 $R_{DS(on)}$, DRAIN-SOURCE ON-RESISTANCE (Ω) 0.09 0.08 0.07 V_{GS} = -4.5V I_D = -5A 0.06 0.05 V_{GS} = -10V 0.04 $I_{D} = -10A$

5 0 25 50 75 100 12 ${
m T_J}$, JUNCTION TEMPERATURE (°C) Figure 18 On-Resistance Variation with Temperature

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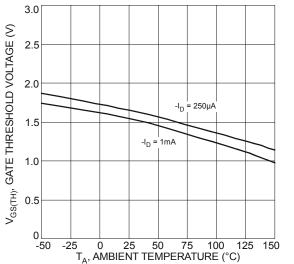
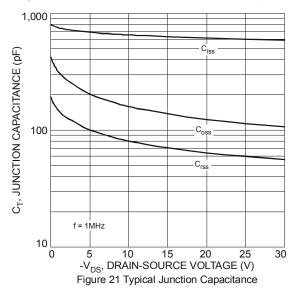


Figure 19 Gate Threshold Variation vs. Ambient Temperature



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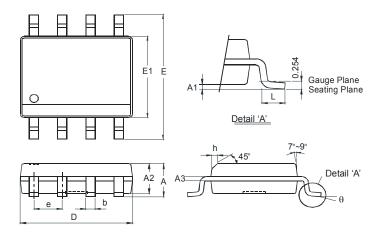
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Package Outline Dimensions

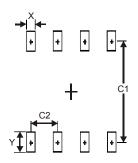
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



SO-8					
Dim	Min	Max			
Α	-	1.75			
A1	0.10	0.20			
A2	1.30	1.50			
A3	0.15	0.25			
b	0.3	0.5			
D	4.85	4.95			
Е	5.90	6.10			
E1	3.85	3.95			
e	1.27	Тур			
h	-	0.35			
L	0.62	0.82			
θ	0°	8°			
All Dimensions in mm					

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
X	0.60
Υ	1.55
C1	5.4
C2	1.27



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